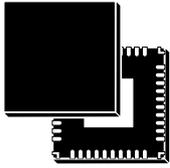


# Next-generation automotive ultra-wideband ranging IC with narrow band radio assist



HWQFN40 (6 x 6 mm)

**Product status link**[ST64UWB-A100](#)

## Features

### Automotive compliance

- AEC-Q100 grade 2 qualified 
- Ambient -40°C to +115°C
- Junction max.: +125°C
- ISO21434 (Automotive Cybersecurity Level 2)
- ISO26262 (ASIL-A)
- 15-year mission profile

### Includes ST state-of-the-art patented technology

### Core

- Arm® 32-bit Cortex®-M85 CPU with DP-FPU, MVE, ETM
- Frequency up to 100 MHz

### GPIOs

- Out of the 20 available GPIOs, a subset is configurable for use as communication-interface pins

### Security

- Arm® TrustZone® with Armv8.1-M mainline security extension
- Arm® PSA and SESIP L3 certifications

### Ultra-wideband radio (UWB)

- Supported standards for UWB radio:
  - IEEE 802.15.4z-2020
  - IEEE802.15.4ab
  - CCC, ICCE
- Antenna ports: 2 × transmit and receive ports
- Supported channels: 5, 6, 8, 9, 10, 12 (6489.6 MHz to 8985.6 MHz)
- Modulation: BPRF, HPRF

### Narrow-band assisted radio (NBA)

- Supported standard for NBA radio
- 1 × antenna Tx/Rx port
- UNII-3 / UNII-5 (5.7-6.4 GHz)

### Communication interfaces

- 2 × SPI, 2 × I2C, FDCAN, USART, LPUART

**Digital temperature sensor****Applications**

- Secure UWB localization
  - SS-TWR, DS-TWR, and AoA, PDoA
  - CCC-Digital key phase 3
  - Car key inside/outside detection

**Package**

- HWQFN40 with wettable flank (6 × 6 mm, 0.5 mm pitch)
- ECOPACK<sup>®</sup> 2 compliant

## 1 Introduction

This document provides information about the ST64UWB-A100, an automotive-grade wireless microcontroller for ultra-wideband ranging applications.

For information on the embedded Arm core, refer to the Cortex<sup>®</sup>-M85 technical reference manual, available from the [www.arm.com](http://www.arm.com) website.

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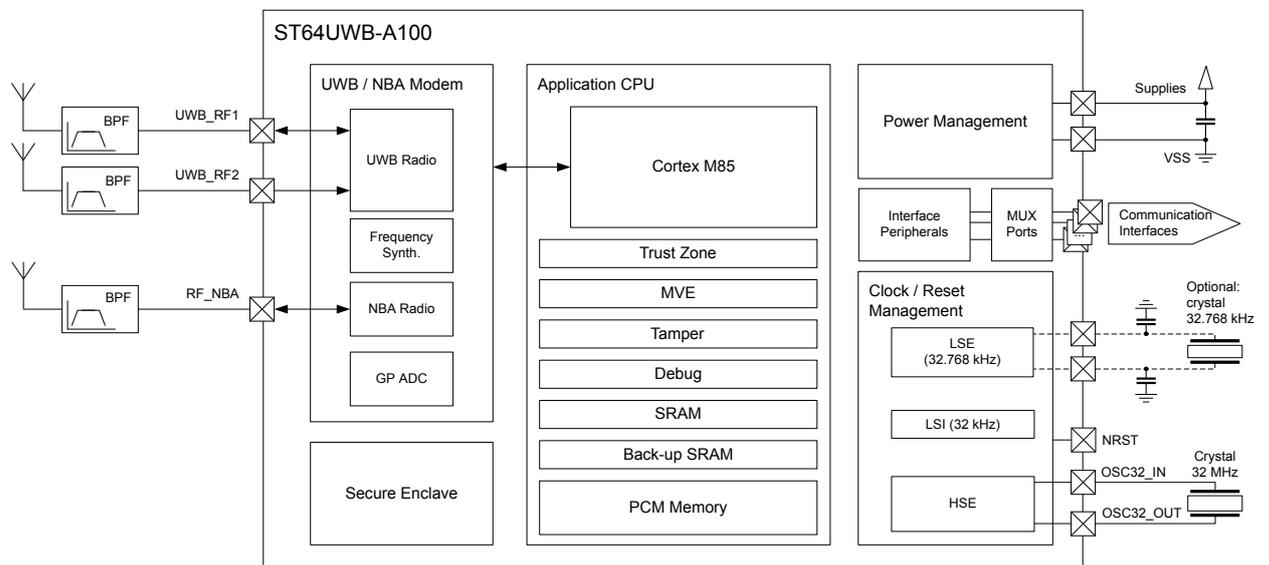
## 2 Description

The ST64UWB-A100 is the first monolithic next-generation automotive ultra-wideband solution from STMicroelectronics. It complies with IEEE 802.15.4ab and uses narrowband-assisted multi-millisecond ranging. Manufactured with 18 nm FDSOI technology, it provides a significantly improved link budget and robust, secure ranging, even in non-line-of-sight conditions.

The ST64UWB-A100 increases range by 50% while maintaining compatibility with legacy IEEE 802.15.4z. It can boost range by up to eight times when operating in IEEE 802.15.4ab mode.

The ST64UWB-A100 features an Arm® Cortex®-M85 core running at up to 100 MHz, integrated PCM and SRAM, automotive connectivity including FDCAN, and advanced security features compliant with SESIP Level 3, ISO 26262 (ASIL A), and AEC-Q100 Grade 2. It is a highly integrated, single-chip platform for secure, reliable, and cost-efficient ultra-wideband automotive applications.

**Figure 1. ST64UWB-A100 series block diagram**



## 3 Package information

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In order to meet environmental requirements, ST offers these devices in different grades of **ECOPACK** packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK is an ST trademark.

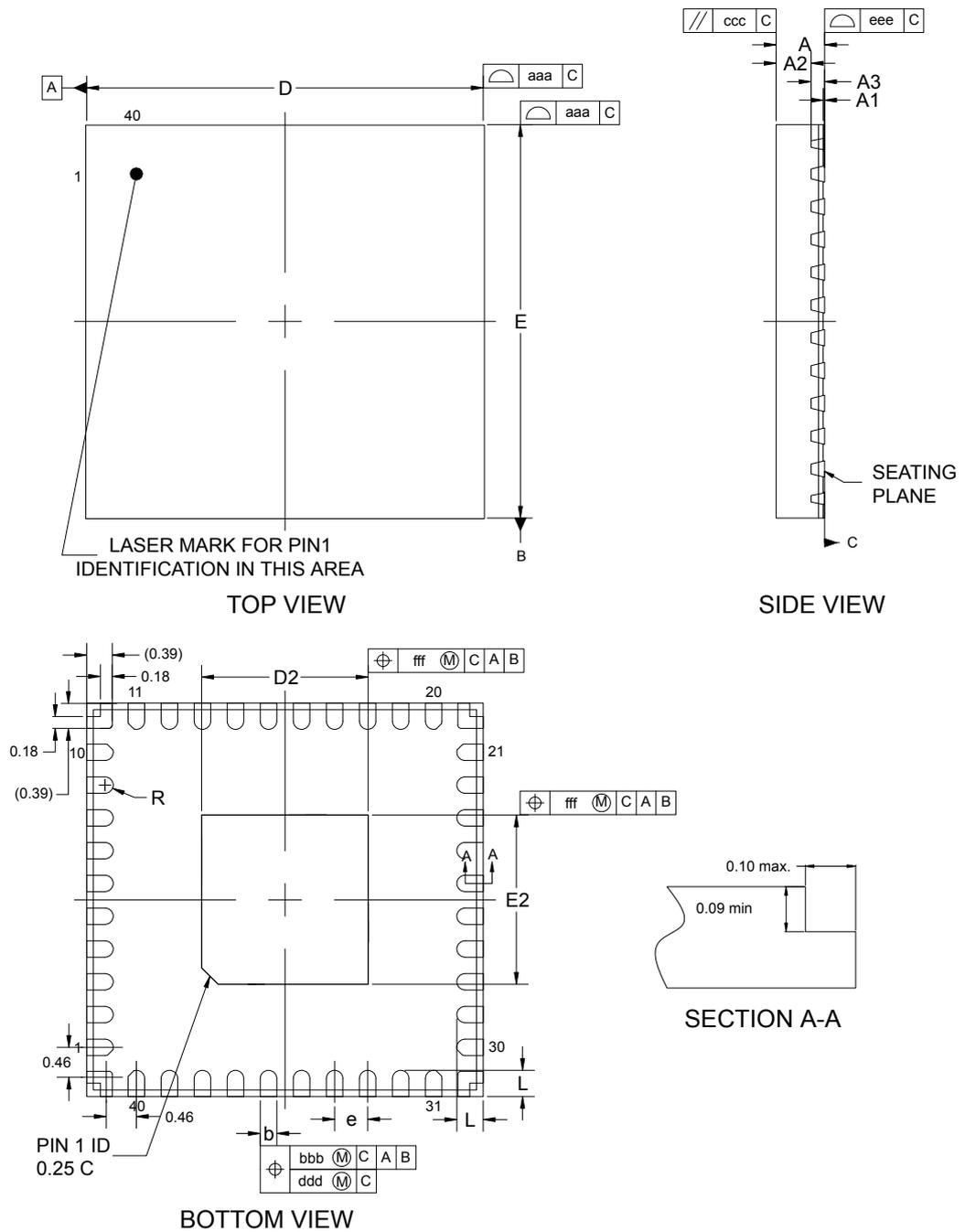
### 3.1 Device marking

Parts marked as "ES", "E" or accompanied by an engineering sample notification letter, are not yet qualified and therefore not approved for use in production. ST is not responsible for any consequences resulting from such use. In no event will ST be liable for the customer using any of these engineering samples in production. ST's Quality department must be contacted prior to any decision to use these engineering samples to run a qualification activity.

### 3.2 HWQFN40 package information

This HWQFN is a 40-pin, 6 x 6 mm, 0.5 mm pitch, thermally enhanced very thin profile quad flat no lead package.

Figure 2. HWQFN40 - Outline



RR\_HWQFN40\_ME\_V3

1. Drawing is not to scale.
2. Dimensioning and tolerances conform to ASME Y14.5M-1994.
3. The pin number 1 identifier must be placed on the top surface of the package using an indentation mark or another feature of the package body.

**Table 1. HWQFN40 - Mechanical data**

Symbol	Millimeters			Inches <sup>(1)</sup>		
	Min	Typ	Max	Min	Typ	Max
A <sup>(2)</sup>	-	-	0.80	-	-	0.0315
A1	0.00	-	0.05	0.0000	-	0.0020
A2	-	0.53	0.58	-	0.0209	0.0228
A3	0.20 REF			0.0079 REF		
b	0.18	0.25	0.30	0.0071	0.0098	0.0118
D	6 BSC <sup>(3)</sup>			0.2362 BSC		
D2	2.42	2.52	2.62	0.0953	0.0992	0.1031
E	6 BSC			0.2362 BSC		
E2	2.48	2.58	2.68	0.0976	0.1016	0.1055
L	0.30	0.40	0.50	0.0118	0.0157	0.0197
e	0.50 BSC			0.0197 BSC		
R	0.09	-	-	0.0035	-	-

1. Values in inches are converted from mm and rounded to four decimal digits.
2. Very very thin profile:  $0.65 < A \leq 0.80$  mm.
3. BSC stands for BASIC dimensions. It corresponds to the nominal value and has no tolerance.

**Table 2. HWQFN40 - Tolerance of form and position**

Symbol	Millimeters			Inches <sup>(1)</sup>		
	Min	Typ	Max	Min	Typ	Max
aaa	0.10			0.0039		
bbb	0.10			0.0039		
ccc	0.10			0.0039		
ddd	0.05			0.0020		
eee	0.08			0.0031		
fff	0.10			0.0039		

1. Values in inches are converted from mm and rounded to four decimal digits.



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## Revision history

**Table 3. Document revision history**

Date	Revision	Changes
09-Mar-2026	1	Initial release.

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